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WORLDWIDE TECHNICAL BULLETINS FOR BROADCAST AND PROFESSIONAL PRODUCTS

Video Products Technical Bulletin 30-2004-032

DATE: February 16, 2004

SUBJECT: NO PICTURE FROM DAMAGE TO Q613 ON G BOARD

MODEL: **BVM-D14H1A**

BVM-D14H1E BVM-D14H1U BVM-D14H5A BVM-D14H5E BVM-D14H5U

The picture may

The picture may disappear if Q613 on the G board is damaged and the protection circuit operates.

PARTS REQUIRED

Part No.	Description	Qty.
1-136-165-00	Cap, 0.1 μF/50V MPS	1

Also Required: Sony bond SC608LVZ or equivalent

SERIAL NO:

BVM-D14H1A2,000,001-2,000,155BVM-D14H1E2,000,001-2,000,270BVM-D14H1U2,000,001-2,000,312BVM-D14H5A2,000,001-2,000,253BVM-D14H5E2,000,001-2,000,268BVM-D14H5U2,000,001-2,001,148

Italicized information in green applies to customers outside the United States.

ORDERING INFORMATION

To order upgrades or for regional service center and parts ordering information, refer to the following document, which lists all contact telephone numbers:

Technical Bulletin 001999000

MODIFICATION PROCEDURE

G Board (Side B, Zone G-2)

- 1. Solder a 0.1 μF capacitor between the base of Q613 and the positive (+) side of C585. (See Figure 1.)
- 2. Affix the capacitor to the board with bond.

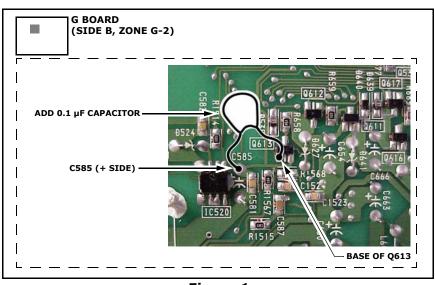


Figure 1

DPMO03-055